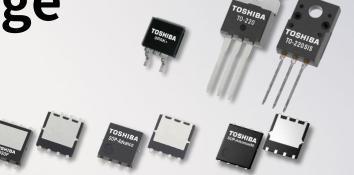
# **TOSHIBA**

# Low Voltage MOSFETs





U-MOS IX-H and X-H are high-efficiency Low Voltage (LV) MOSFET series, specifically designed for use in the secondary side of AC/DC power supplies for power adapters and servers in datacenter as well as DC/DC converter. The mentioned U-MOS –series are also suitable for motor drives, UPS and machine tools. U-MOS X-H and selected U-MOS IX-H are adopting a new cell structure that reduce the voltage spikes and ringing during switching which contributes for greater higher efficiency. Since UMOS-X options with highspeed diodes for minimized  $\,Q_{rr}\,$  got available. Moreover, the new SOP Advance (E) package in 5 x 6 mm dimension for improved power density is introduced.

### Applications

- Power supplies
- Industry automation
- Servers
- Power adapters
- UPS
- Power tools
- · Battery packs

#### **Features**

- Latest U-MOS IX-H / X-H trench process, complementing U-MOS-VIII line-up to cover V<sub>DSS</sub> (30V-250V)
- Top-level performance in onresistance per die area (R<sub>ON</sub> · \*A)
- Improving trade off between  $R_{DS(ON)}$  and  $Q_g/Q_{sw}/Q_{oss}$
- T<sub>ch,max</sub>: 175°C since U-MOS IX-H
- UMOS11-H for optimized  $R_{ON} \& Q_{rr}$
- Low spike option since U-MOS IX-H

#### **Advantages**

- Wide product line-up is applicable in various power applications
- Significantly better trade-offs between on-resistance (R<sub>DS(ON</sub>) and charge characteristics allow high efficiency switching
- More thermal safety head room
- Ideal for applications that require power density, smaller size etc.
- Less EMI effects at low spike type

#### Benefits

- Attractive cost effects
  - Lower system costs due to fast switching & smaller form factor
  - Low service costs based on increased lifetime (cooler system) to reduce costs of operation failures
- Smart performance increases
  - Improved end product quality
  - Improved competitiveness

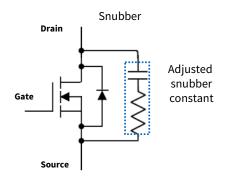
U-MOS - series	Application examples
U-MOS 11-H: lowest R <sub>ON</sub> & Q <sub>rr</sub> , low spike, T <sub>ch,max</sub> : 175°C,	For server, DC/DC converter, synchronous rectifier
$ \begin{array}{c} \text{U-MOS X-H: low spike, $T_{ch,max}$: $175^{\circ}$C, narrow $V_{th}$ distribution,} \\ \hline \textbf{NEW} & \text{Improved $R_{DS(ON)}$} \times Q_g, $R_{DS(ON)}$} \times Q_{SW}, $R_{DS(ON)}$} \times Q_{OSS} \\ \end{array} $	For server, DC/DC converter, synchronous rectifier
U-MOS IX-H: T <sub>ch,max</sub> : 175°C, low Q <sub>oss</sub> & low Q <sub>sw</sub>	For server, DC/DC converter, motor drives, power supply
U-MOS VIII-H: up to high voltages 250V	For general switching

#### U-MOS highlights

Aiming to simplify design engineer's job whilst offering maximized MOSFET performance, Toshiba developed various solutions.

#### Low spike technology

Toshiba is enabling switching noise reduction by adopting improved snubber functionality for selected 40V & 60V U-MOS IX-H and all U-MOS X-H series. With this new technology, Toshiba can offer low voltage spike and ringing for both resistive and inductive loads.



#### TPH1R306PL high speed switch type

# 20ns/div 20ns/div 10us/div

#### Example:

60V,  $1.3m\Omega$ SOP Advance (5x6mm)

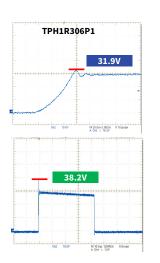
# R-load switching waveform

 $V_{DD}$ =30V,  $I_{D}$ =50A  $R_{G}$ =4.7 $\Omega$ ,  $R_{GS}$ =4.7 $\Omega$ Resistance load Ta=25°C

## L-load switching waveform (t<sub>rr</sub>)

 $V_{DD}$ =30V  $I_{DR}$ =25A di/dt = 220A/ $\mu$ s Ta=25°C

#### TPH1R306P1 low spike type



#### NEW: SOP Advance (E) Package for enhanced power density

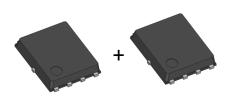
Package comparison with standard 5x6 package, SOP Advance(N) SOP Advance (E):

Lower package resistance (- 33%)
Enlarged mountable chip size (+23%)
Thermal resistance reduction (-15%)



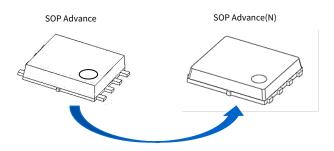
#### Improved V<sub>th</sub> distribution for simplified paralleling of MOSFETs

Since U-MOS X-H the distribution of threshold voltage is narrowed. UMOS VIII-H example: TPH4R008NH  $V_{gs(th)}$  between 2.0V~4.0V  $\rightarrow$  2V window. UMOS X-H example: TPH4R008QM  $V_{gs(th)}$  between 2.5V~3.5V  $\rightarrow$  1V window. Advantage: Simplified paralleling in power applications is possible.



#### SOP Advance (N) package

Toshiba is offering beside SOP Advance an additional package option for the surface mounted 5x6mm: SOP Advance(N), targeting to improve footprint compatibility. Where available, the datasheet will indicate both options.



#### U-MOS VIII-H, U-MOS IX-H & U-MOS X-H – Product line-up 30V ~ 60V

V <sub>DSS</sub> (V)	$\begin{array}{c} R_{DS(ON)} \\ in \ m\Omega \end{array}$	TO-220SIS	TO-220	SOP Advance 5x6mm	SOP Advance (N) 5x6mm	DSOP Advance 5x6mm	TSON Advance 3x3mm	DPAK
				Diman	Strong			
	10-20			TPH11003NL			TPN11003NL	
	5-10			TPH8R903NL TPH6R003NL			TPN8R903NL TPN6R003NL TPN5R203PL*	
30	3-5			TPH4R803PL* TPH4R003NL TPH3R203NL			TPN4R303NL	
	1-3			TPH3R003PL* TPH2R903PL* TPH2R003PL*	TPH1R403NL1		TPN2R703NL TPN2R903PL* TPN1R603PL*	
	<1				TPHR9003NL1 TPHR9203PL1* TPHR6503PL1*	TPWR8503NL TPWR6003PL*		
	5-10			TPH7R204PL* TPH6R004PL*			TPN7R504PL*	
	3-5	TK3R1A04PL*	TK3R1E04PL*	TPH3R704PL*			TPN3R704PL*	TK3R1P04PL*
40	1-3			TPH2R104PL* TPH1R204PB**	TPH1R204PL* TPH1R204PL1*		TPN2R304PL*	
	<1		COMIN		TPHR8504PL1*	TPWR8004PL*		
45	1-3		SOON	TPH1R405PL* TPH1R005PL*		TPW1R005PL*	TPN2R805PL*	
	20-30						TPN22006NH	
	10-20	TK30A06N1 TK40A06N1	TK30E06N1 TK40E06N1	TPH14006NH TPH11006NL			TPN14006NH TPN11006PL*	
60	5-10	TK58A06N1 TK8R2A06PL* TK5R3A06PL*	TK58E06N1 TK8R2E06PL* TK5R1E06PL*	TPH9R506PL* TPH7R506NH TPH7R006PL* TPH5R906NH			TPN7R506NH TPN7R006PL*	TK6R7P06PL*
	3-5	TK4R3A06PL* TK3R3A06PL*	TK4R3E06PL* TK3R2E06PL*	TPH4R606NH TPH3R506PL*			TPN4R806PL*	TK4R4P06PL*
	1-3	TK100A06N1	TK100E06N1	TPH1R306P1**	TPH1R306PL1* TPH2R506PL* TPH2R306PL1* TPH2R306NH1	TPW1R306PL*		

 $<sup>^{\</sup>star}\,\text{U-MOS\,IX-H\,technology;}\,^{\star\star}\,\text{U-MOS\,IX-H\,low\,spike\,technology;}\,^{\star\star\star}\text{U-MOS\,X-H\,\,technology;}\,^{\star\star\star\star}\,\text{U-MOS\,I1-H}$ 



#### U-MOS VIII-H, U-MOS IX-H & U-MOS X-H – Product line-up 75V ~ 150V

V <sub>DSS</sub> (V)	$R_{DS(ON)}$ in $m\Omega$	TO-220SIS	TO-220	SOP Advance 5x6mm	SOP Advance(N) 5x6mm	SOP Advance(E) 5x6mm	DSOP Advance 5x6mm	TSON Advance 3x3mm	DPAK
				The same of the sa					
75	1-3			TPH2R608NH			TPW2R508NH		
80	20-50							TPN30008NH	
	10-20	TK35A08N1	TK35E08N1	TPH12008NH				TPN19008QM*** TPN12008QM***	
	5-10	TK46E08N1 TK72A08N1 TK6R8A08QM*** TK5R1A08QM***	TK46E08N1 TK72E08N1 TK7R0E08QM*** TK5R3E08QM***	TPH8R008NH	TPH8R008QM***			TPN8R408QM***	TK6R9P08QM*** TK5R1P08QM***
	1-5	TK3R2A08QM*** TK100A08N1 TK2R4A08QM***	TK3R3E08QM*** TK100E08N1 TK2R4E08QM***	TPH2R408QM***	TPH4R008NH1 TPH4R008QM*** TPH3R008QM*** TPH2R408QM***	TPM1R908QM***	TPW4R008NH		
	20-50							TPN3300ANH	
100	10-20	TK22A10N1 TK110A10PL*	TK22E10N1* TK110E10PL*	TPH1400ANH				TPN1600ANH TPN1200APL*	TK110P10PL*
	5-10	TK34A10N1 TK40A10N1 TK7R4A10PL* TK6R7A10PL*	TK34E10N1 TK40E10N1 TK7R2E10PL* TK6R4E10PL*	TPH8R80ANH TPH6R30ANL TPH5R60APL*					TK7R7P10PL*
	3-5	TK65A10N1 TK4R1A10PL* TK100A10N1 TK3R2A10PL*	TK65E10N1 TK3R9E10PL* TK100E10N1	TPH4R10ANL	TPH4R50ANH1 TPH3R70APL1* TPH3R10AQM***		TPW4R50ANH TPW3R70APL*		
	<3		TK2R9E10PL*	NEW	TPH2R70AR5*****				
	10-20	TK32A12N1	TK32E12N1						
120	5-10	TK42A12N1 TK56A12N1	TK42E12N1 TK56E12N1						
	3-5	TK72A12N1	TK72E12N1						
150	50-100			TPH5900CNH				TPN5900CNH	
	20-50			TPH3300CNH			NEW	TPN4800CQH***	
	4-20	TK9R7A15CQ5**** TK7R4A15CQ5**** TK5R0A15CQ5**** NEW	TK9R6E15CQ5**** TK7R2E15CQ5**** TK4R9A15CQ5**** NEW	NEW NEW NEW	TPH1500CNH1 TPH1100CQ5**** TPH1400CQH*** TPH1400CQ5**** TPH9R00CQH*** TPH9R00CQ5 ****		TPW1500CNH		
200	100-200			TPH1110ENH				TPN1110ENH	
	50-100			TPH6400ENH					
	20-50			TPH2900ENH			TPW2900ENH		
250	200-300			TPH2010FNH				TPN2010FNH	
	100-200			TPH1110FNH					
	50-100			TPH5200FNH			TPW5200FNH		

<sup>\*</sup> U-MOS IX -H technology; \*\* U-MOS IX-H low spike technology; \*\*\*\*U-MOS X-H technology \*\*\*\*\* U-MOS X-H with high speed diode \*\*\*\*\*\* U-MOS11-H with high speed diode